

FAST RECOVER EPITAXIAL DIODE (FRED)

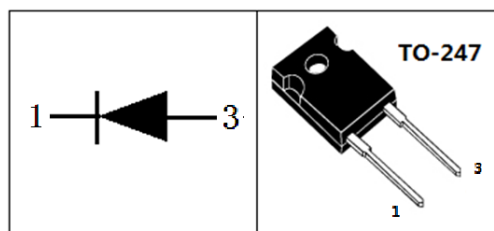
Features

- Planar passivated chips
- Very short recovery time
- Extremely low switching losses
- Low I_{RM} values
- Soft recovery behaviour
- 100% avalanche tested

$V_{RRM} = 1200\text{ V}$	$I_{FAVM} = 75\text{ A}$
V_F (typ) = 2.0V ($I_F=75\text{A}, T_{VJ}=25^\circ\text{C}$)	
$t_{rr} < 90\text{ ns}$ ($I_F = 1\text{ A}; di/dt = 200\text{ A/s}$)	
Package	TO247-2L

Applications

- Antiparallel diode for high frequency switching devices
- Anti saturation diode
- Snubber diode
- Free wheeling diode in converters and motor control circuits
- Rectifiers in switch mode power supplies (SMPS)
- Inductive heating and melting
- Uninterruptible power supplies (UPS)
- Ultrasonic cleaners and welders



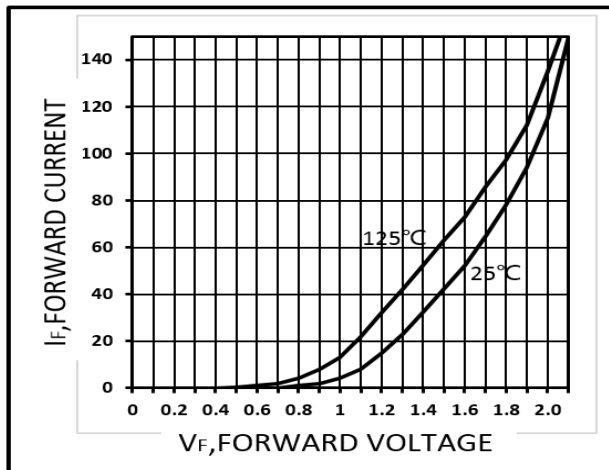
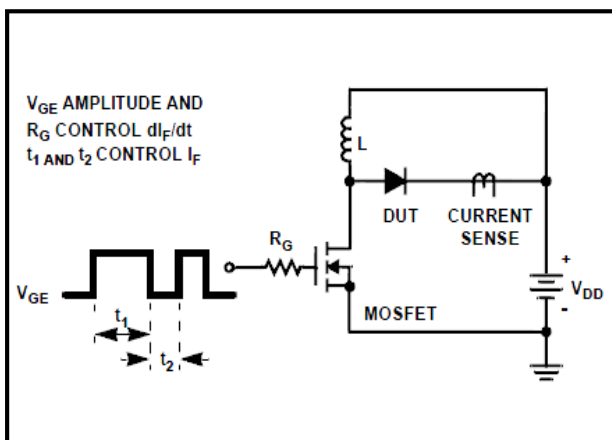
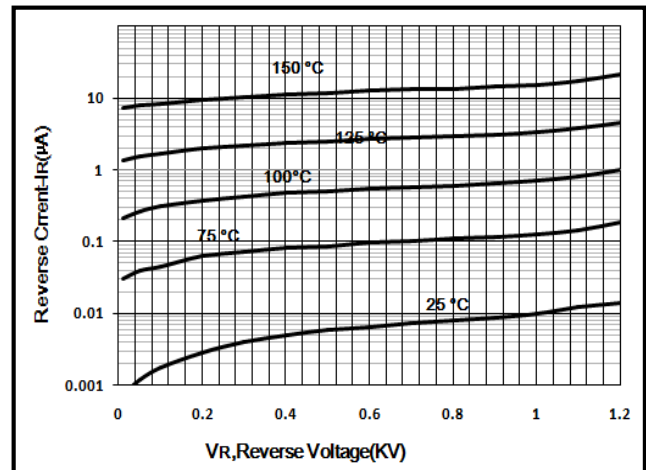
Absolute Maximum Ratings

Symbol	Parameter	Value	Units
V_{RRM}	Peak Repetitive Reverse Voltage	1200	V
$I_{F(AV)}$	Diode Continuous Forward Current ($T_C=100^\circ\text{C}$)	75	A
I_{FRM}	Repetitive Peak Surge Current (20kHz Square Wave)	150	A
I_{FSM}	Nonrepetitive Peak Surge Current (Halfwave 1 Phase 60Hz)	750	A
T_J	Operating Junction Temperature Range	-55 to +150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to +150	$^\circ\text{C}$

ELECTRICAL SPECIFICATIONS ($T_J = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_R	Cathode to Anode Breakdown Voltage	$I_R = 100\mu\text{A}$	1200			
V_F	Diode Forward Voltage	$I_F=75\text{A } T_C=25^\circ\text{C}$		2.0	2.7	V
	Diode Forward Voltage	$I_F=75\text{A } T_C=125^\circ\text{C}$		1.8	2.5	V
I_{RM}	Maximum Reverse Leakage Current	$V_R=1200\text{V } T_C=25^\circ\text{C}$			10	μA
		$V_R=1200\text{V } T_C=125^\circ\text{C}$			100	μA

DYNAMIC RECOVERY CHARACTERISTICS(T _J = 25 °C unless otherwise specified)						
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
I_{RRM}	Diode Peak Reverse Recovery Current	V _{DD} =100V;I _F =1A; dif/dt=200A/μs; See Fig.4		5.1		A
Q_{rr}	Reverse recovery charge (Area Under the Curve Defined by I _{RRM} and trr).			250		nc
trr	Diode Reverse Recovery Time			75	90	ns
S	S= tb/ta			0.6		
I_{RRM}	Diode Peak Reverse Recovery Current	V _{DD} =800V;I _F =30A; dif/dt=850A/μs; See Fig.4		27		A
Q_{rr}	Reverse recovery charge (Area Under the Curve Defined by I _{RRM} and trr).			910		nc
trr	Diode Reverse Recovery Time			112		ns
S	S= tb/ta			1.26		

Fig.1 Forward Current vs Forward Voltage

Fig.3 trr Test Circuit

Fig.2 Reverse Current vs Reverse Voltage

Fig.4 trr Waveforms and Definitions
